### PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Reel Size	Tape Width	<b>Shipping</b> <sup>†</sup>
FDD86367	FDD86367	DPAK3 (TO-252 3 LD) (Pb-Free)	13"	16 mm	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Cor	ndition	Min	Тур	Max	Unit
OFF CHAF	RACTERISTICS						
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$		80	-	-	V
I <sub>DSS</sub>	Drain-to-Source Leakage Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V	$T_J = 25^{\circ}C$	-	-	1	mA
			$T_J = 175^{\circ}C$ (Note 4)	-	-	1	mA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	V <sub>GS</sub> = ±20 V		-	-	±100	nA
ON CHAR	ACTERISTICS						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$		2	3	4	V
R <sub>DS(on)</sub>	Drain to Source On Resistance	I <sub>D</sub> = 80 A, V <sub>GS</sub> = 10 V	$T_J = 25^{\circ}C$	-	3.3	4.2	mΩ
			T <sub>J</sub> = 175°C (Note 4)	_	6.6	8.4	mΩ
YNAMIC	CHARACTERISTICS	-					-
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	4840	-	pF
C <sub>oss</sub>	Output Capacitance			-	814	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			-	31	-	pF
Rg	Gate Resistance	V <sub>GS</sub> = 0.5 V, f = 1 MHz		-	2.3	-	Ω
Q <sub>g(ToT)</sub>	Total Gate Charge	$V_{GS}$ = 0 to 10 V	$V_{DD} = 40 V,$	-	68	88	nC
Q <sub>g(th)</sub>	Threshold Gate Charge	$V_{GS} = 0$ to 2 V	I <sub>D</sub> = 80 A	-	8.8	-	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge	V <sub>DD</sub> = 40 V, I <sub>D</sub> = 80 A		-	22	-	nC
Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge			_	14	_	nC

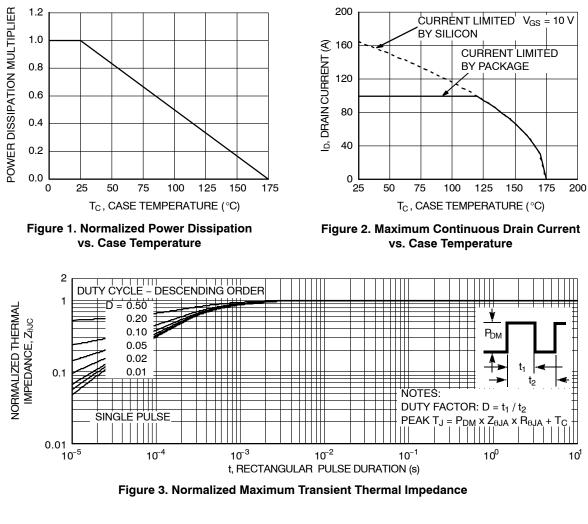
t <sub>on</sub>	Turn–On Time	$V_{DD}$ = 40 V, I_D = 80 A, V_{GS} = 10 V, $R_{GEN}$ = 6 $\Omega$	-	-	104	ns
t <sub>d(on)</sub>	Turn-On Delay	$H_{GEN} = 0.52$	-	20	-	ns
t <sub>r</sub>	Rise Time		-	49	-	ns
t <sub>d(off)</sub>	Turn-Off Delay		-	36	-	ns
t <sub>f</sub>	Fall Time		-	16	-	ns
t <sub>off</sub>	Turn–Off Time		-	-	80	ns

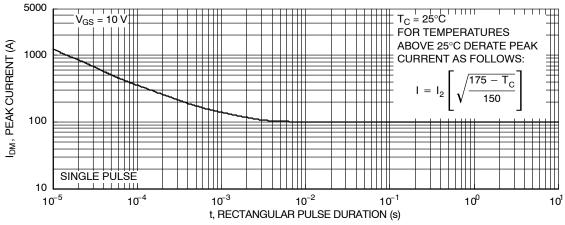
#### DRAIN-SOURCE DIODE CHARACTERISTICS

$V_{SD}$	Source-to-Drain Diode Voltage	I <sub>SD</sub> = 80 A, V <sub>GS</sub> = 0 V	-	-	1.3	V
		$I_{SD}$ = 40 A, $V_{GS}$ = 0 V	-	-	1.2	V
t <sub>rr</sub>	Reverse-Recovery Time	$V_{DD}$ = 64 V, $I_F$ = 80 A, $dI_{SD}/dt$ = 100 A/ $\mu s$	-	68	102	ns
Q <sub>rr</sub>	Reverse-Recovery Charge		-	66	106	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at  $T_J = 175^{\circ}$ C. Product is not tested to this condition in production.

## **TYPICAL CHARACTERISTICS**







## TYPICAL CHARACTERISTICS (continued)

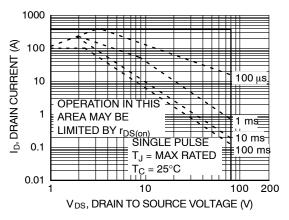
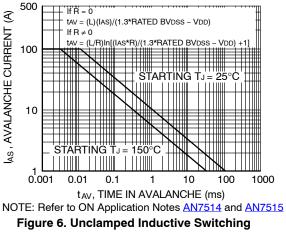


Figure 5. Forward Bias Safe Operating Area



Capability

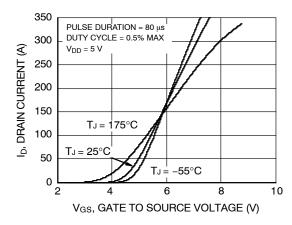


Figure 7. Transfer Characteristics

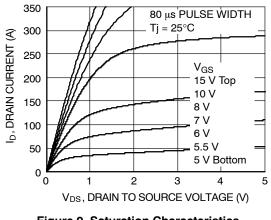
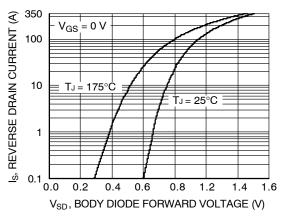
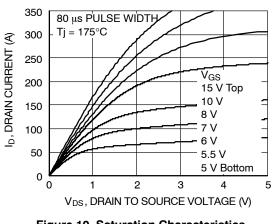


Figure 9. Saturation Characteristics

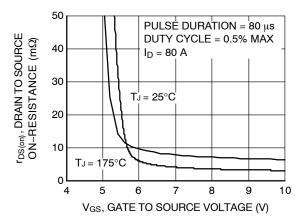


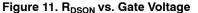






#### TYPICAL CHARACTERISTICS (continued)





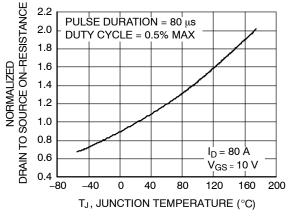


Figure 12. Normalized RDSON vs. Junction Temperature

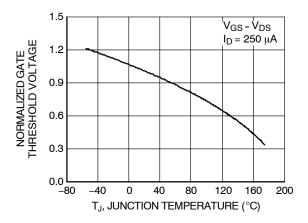


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

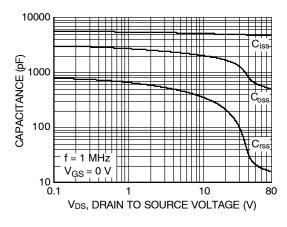


Figure 15. Capacitance vs. Drain to Source Voltage

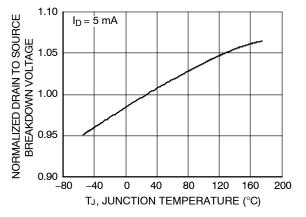


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

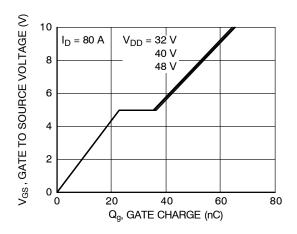
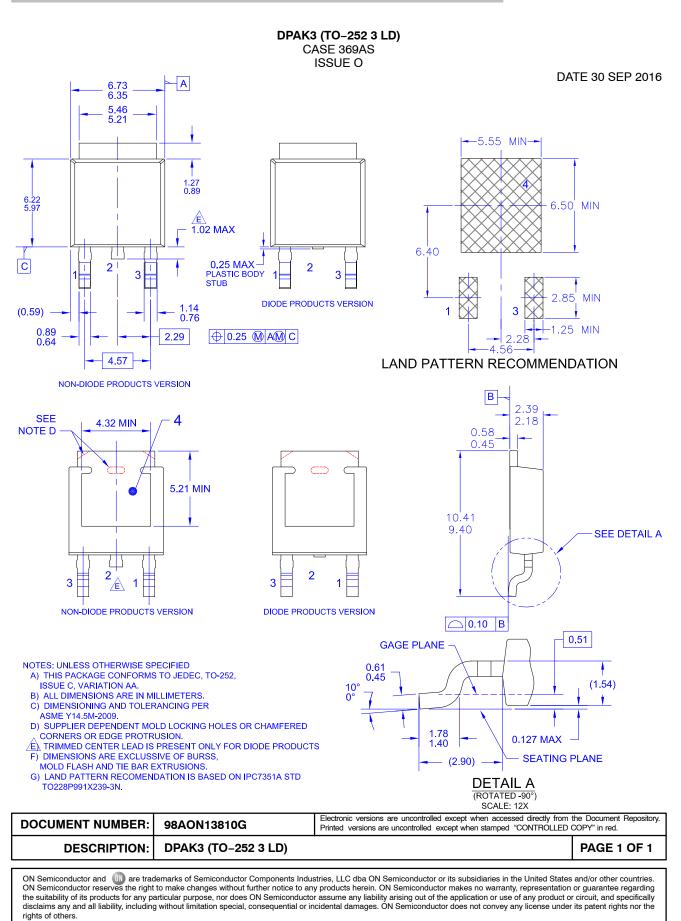


Figure 16. Gate Charge vs. Gate to Source Voltage

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